



**SPECIFICATION  
FOR  
LCM+CTP Module  
KD050HDFIA020-C020C**

MODULE:	KD050HDFIA020-C020C
CUSTOMER:	

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## Revision History

[illegible]

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ISO9001 : 2008

ISO/TS16949 : 2009

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## \* Description

This is a color active matrix TFT (Thin Film Transistor) LCD (liquid crystal display) that uses amorphous silicon TFT as a switching device. This model is composed of a Transmissive type TFT-LCD Panel, driver circuit, back-light unit. The resolution of a 5.0'TFT-LCD contains 720x1280 pixels, and can display up to 65K/262K/16.7M colors.

## \* Features

- Low Input Voltage: 3.3V(TYP)
- Display Colors of TFT LCD: 65K/262K/16.7M colors
- TFT-Interface: 4 Lane MIPI
- CTP-Interface: I2C

General Information Items	Specification	Unit	Note
	Main Panel		
Display area(AA)	62.10(H)*110.40(V) (5.0inch)	mm	-
Driver element	TFT active matrix	-	-
Display colors	65K/262K/16.7M	colors	-
Number of pixels	720(RGB)*1280	dots	-
TFT Pixel arrangement	RGB vertical stripe	-	-
Pixel pitch	0.08625(H)*0.08625(V)	mm	-
Viewing angle	ALL	o'clock	-
TFT Controller IC	ILI9881C	-	-
CTP Driver IC	GT911	-	-
Display mode	Transmissive/Normally Black	-	-
Touch mode	5-points and Gestures	-	-
Module Bonding Type	TAPE Bonding	-	-
Operating temperature	-20~+70	°C	-
Storage temperature	-30~+80	°C	-

## \* Mechanical Information

Item		Min.	Typ.	Max.	Unit	Note
Module size	Horizontal(H)		67.56		mm	-
	Vertical(V)		122.35		mm	-
	Depth(D)		4.03		mm	-
Weight					g	-

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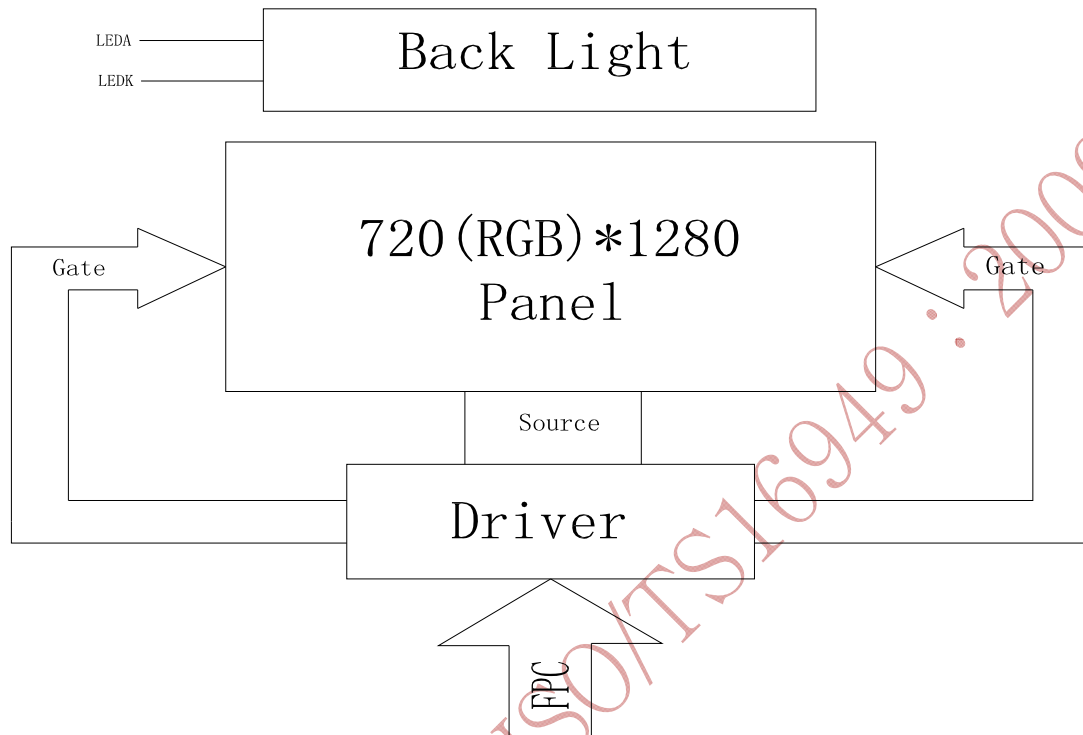
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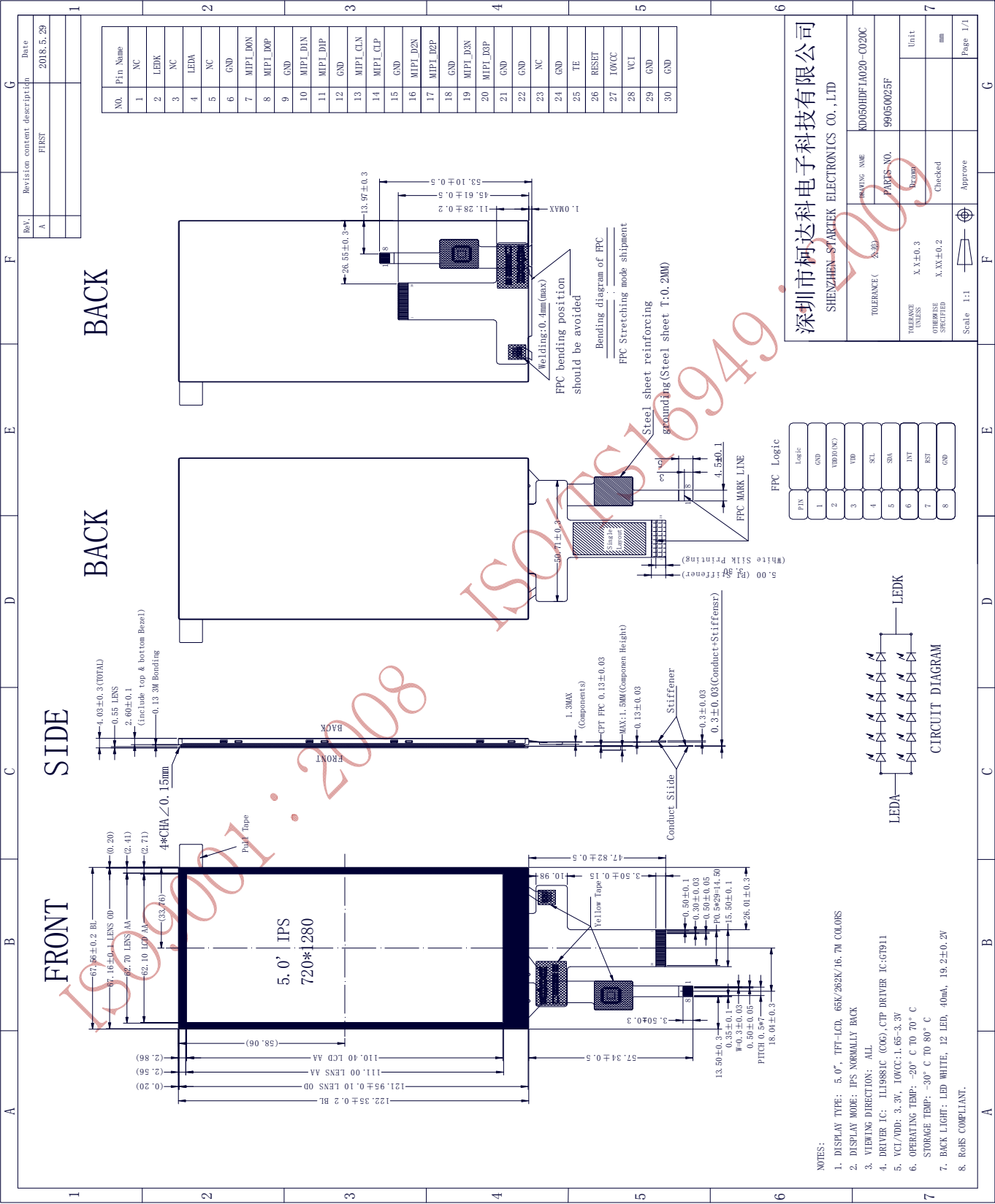


## 1. Block Diagram



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2. Outline dimension





### 3. Input terminal Pin Assignment

#### 3.1 TFT

NO.	SYMBOL	DISCRIPTION	I/O
1	NC		
2	LEDK	Cathode pin of backlight.	P
3	NC		
4	LEDA	Anode pin of backlight.	P
5	NC		
6	GND	Ground.	P
7	MIPI_D0N	- MIPI DSI differential data pair. (Data lane 0) Leave it open or fix to GND level when not in use.	I
8	MIPI_D0P		I
9	GND	Ground.	P
10	MIPI_D1N	- MIPI DSI differential data pair. (Data lane 1) Leave it open or fix to GND level when not in use.	I
11	MIPI_D1P		I
12	GND	Ground.	P
13	MIPI_CLN	- MIPI DSI differential clock pair Leave it open or fix to GND level when not in use.	I
14	MIPI_CLP		I
15	GND	Ground.	P
16	MIPI_D2N	- MIPI DSI differential data pair. (Data lane 2) Leave it open or fix to GND level when not in use.	I
17	MIPI_D2P		I
18	GND	Ground.	P
19	MIPI_D3N	- MIPI DSI differential data pair. (Data lane 3) Leave it open or fix to GND level when not in use.	I
20	MIPI_D3P		I
21	GND	Ground.	P
22	GND	Ground.	P
23	NC		
24	GND	Ground.	P





25	TE	- Tearing effect output pin. Leave the pin open when not in use.	O
26	RESET	- The external reset input Initializes the chip with a low input. Be sure to execute a power-on reset after supplying power. Fix to IOVCC level when not in use.	I
27	IOVCC	- Power supply for internal logic regulator. Connect to an external power supply of 1.65V to 3.3V	P
28	VCI	- Power supply for analog circuits. Connect to an external power supply of 2.5V to 3.3V	P
29	GND	Ground.	P
30	GND	Ground.	P

### 3.2 CTP

NO.	SYMBOL	DISCRIPTION	I/O
1	GND	Ground.	P
2	NC		
3	VDD	Supply voltage.	P
4	SCL	I2C clock input.	I
5	SDA	I2C data input and output	I/O
6	INT	External interrupt to the host.	I
7	RST	External Reset, Low is active.	I
8	GND	Ground.	P

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## 4. LCD Optical Characteristics

### 4.1 Optical specification

Item		Symbol	Condition	Min.	Typ.	Max.	Unit.	Note
Contrast Ratio		CR	$\Theta=0$ Normal viewing angle	640	800	--		(1)(2)
Response time	Rising	T <sub>R</sub>		--	10	15	msec	(1)(3)
	Falling	T <sub>F</sub>		--	20	25		
Color gamut		S(%)		--	70	--	%	C-light
Color Filter Chromaticity	White	W <sub>X</sub>		0.276	0.316	0.356	-	(1)(4) CF glass
		W <sub>Y</sub>		0.296	0.336	0.376		
	Red	R <sub>X</sub>		0.611	0.631	0.651		
		R <sub>Y</sub>		0.319	0.339	0.359		
	Green	G <sub>X</sub>		0.300	0.320	0.340		
		G <sub>Y</sub>		0.587	0.607	0.627		
	Blue	B <sub>X</sub>		0.131	0.151	0.171		
		B <sub>Y</sub>		0.025	0.045	0.065		
Viewing angle	Hor.	$\Theta_L$	CR>10	--	80	--	-	(1)(4) Measuring with Polarizer, Reference Only
		$\Theta_R$		--	80	--		
	Ver.	$\Theta_U$		--	80	--		
		$\Theta_D$		--	80	--		
Option View Direction							Free	(5)

### 4.2 Measuring Condition

- Measuring surrounding: dark room
- Ambient temperature:  $25 \pm 2^\circ\text{C}$
- 15min. warm-up time.

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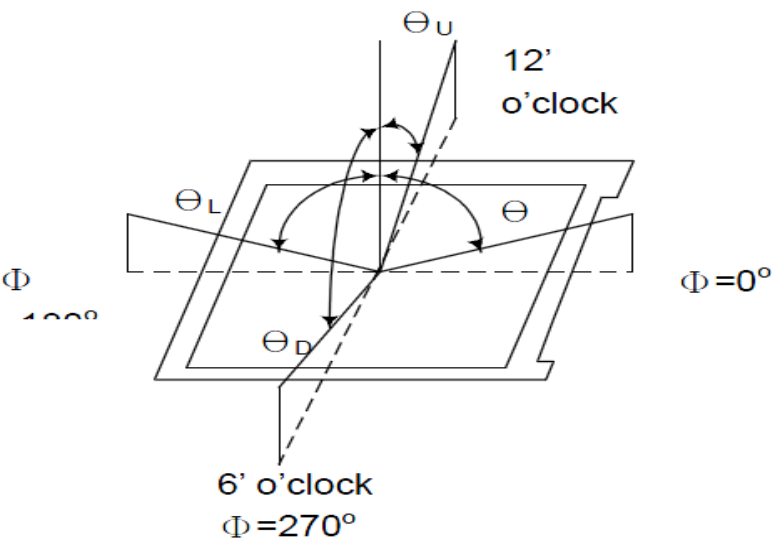
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### 4.3 Measuring Equipment

FPM520 of Westar Display technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics

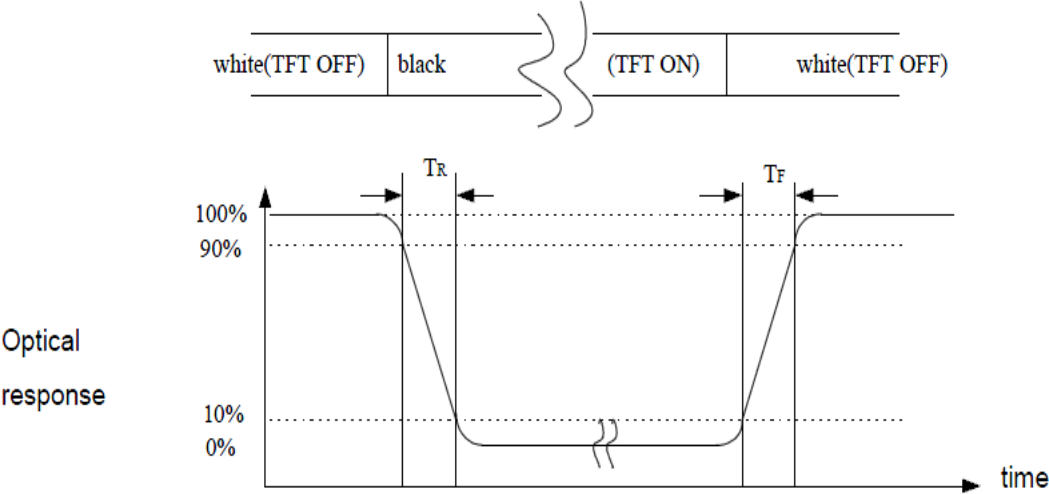
Note (1) Definition of Viewing Angle:



Note (2) Definition of Contrast Ratio (CR) :  
measured at the center point of panel

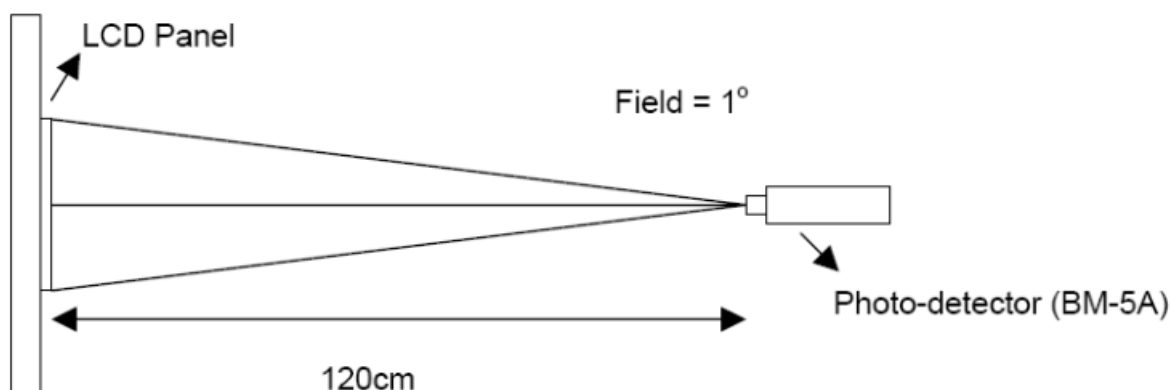
$$CR = \frac{\text{Luminance with all pixels white}}{\text{Luminance with all pixels black}}$$

Note (3) Definition of Response Time : Sum of  $T_R$  and  $T_F$

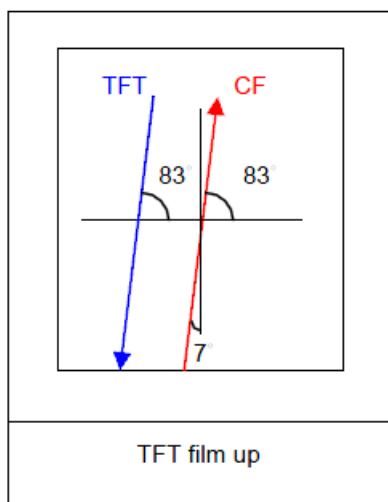




Note (4) Definition of optical measurement setup



Note (5) Rubbing Direction (The different Rubbing Direction will cause the different optima view direction. )



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## 5. TFT Electrical Characteristics

### 5.1 Absolute Maximum Rating (Ta=25 VSS=0V)

Characteristics	Symbol	Min.	Max.	Unit
Digital Supply Voltage	VCI	-0.3	6.5	V
Digital interface supply Voltage	IOVCC	-0.3	3.3	V
Operating temperature	T <sub>OP</sub>	-20	+70	°C
Storage temperature	T <sub>ST</sub>	-30	+80	°C

NOTE: If the absolute maximum rating of even is one of the above parameters is exceeded even momentarily, the quality of the product may be degraded. Absolute maximum ratings, therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the range of the absolute maximum ratings.

### 5.2 DC Electrical Characteristics

Characteristics	Symbol	Min.	Typ.	Max.	Unit	Note
Digital Supply Voltage	VCC	2.5	3.3	6.0	V	--
Digital interface supply Voltage	IOVCC	1.65	1.8	3.3	V	--
Normal mode Current consumption	IDD	--	40	--	mA	--
Level input voltage	V <sub>IH</sub>	0.7 IOVCC	--	IOVCC	V	--
	V <sub>IL</sub>	-0.3	--	0.3 IOVCC	V	--
Level output voltage	V <sub>OH</sub>	0.8* IOVCC	--	IOVCC	V	--
	V <sub>OL</sub>	GND	--	0.2 IOVCC	V	--

### 5.3 LED Backlight Characteristics

The back-light system is edge-lighting type with 12 chips White LED

Item	Symbol	Min.	Typ.	Max.	Unit	Note
Forward Current	I <sub>F</sub>	30	40	--	mA	--
Forward Voltage	V <sub>F</sub>	--	19.2	--	V	--
LCM Luminance	L <sub>V</sub>	380	420	--	cd/m2	Note3
LED life time	Hr	50000			Hour	Note1,2

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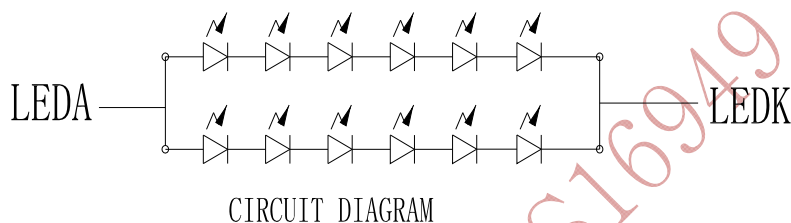
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Uniformity	AVg	80	--	--	%	Note3
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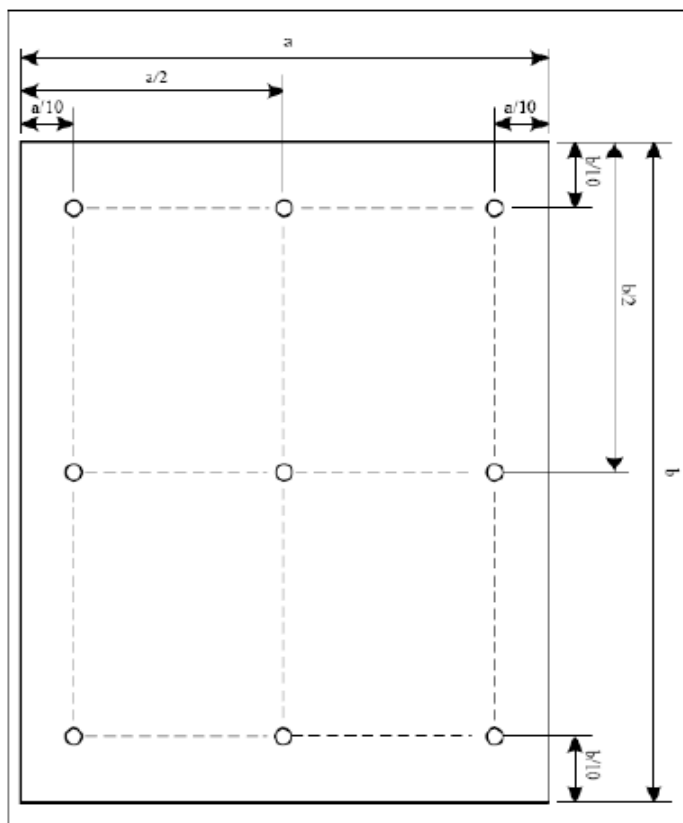
Note (1) LED life time (Hr) can be defined as the time in which it continues to operate under the condition:  $T_a=25\pm3\text{ }^{\circ}\text{C}$ , typical IL value indicated in the above table until the brightness becomes less than 50%.

Note (2) The "LED life time" is defined as the module brightness decrease to 50% original brightness at  $T_a=25^{\circ}\text{C}$  and  $I_L=40\text{mA}$ . The LED lifetime could be decreased if operating  $I_L$  is larger than 40mA. The constant current driving method is suggested.





NOTE 3: Luminance Uniformity of these 9 points is defined as below:



$$\text{Uniformity} = \frac{\text{minimum luminance in 9 points (1-9)}}{\text{maximum luminance in 9 points (1-9)}}$$

$$\text{Luminance} = \frac{\text{Total Luminance of 9 points}}{9}$$

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## 6. MIPI Interface Characteristics

### 6.1 High Speed Mode – Clock Channel Timing

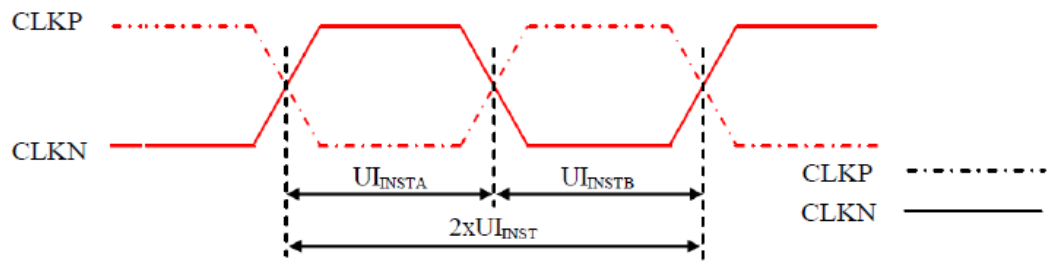


Figure 118: DSI Clock Channel Timing

Table 38: DSI Clock Channel Timing

Signal	Symbol	Parameter	Min	Max	Unit
CLKP/N	$2xUI_{INST}$	Double UI instantaneous	4	25	ns
CLKP/N	$UI_{INSTA}, UI_{INSTB}$ (Note 1)	UI instantaneous Half	2 (Note 2)	12.5	ns

**Notes:**

- $UI = UI_{INSTA} = UI_{INSTB}$
- Define the minimum value of 24 UI per Pixel, see Table 39.

Table 39: Limited Clock Channel Speed

Data type	Two Lanes speed	Three Lanes speed	Four Lanes speed
Data Type = 00 1110 (0Eh), RGB 565, 16 UI per Pixel	566 Mbps	433 Mbps	366 Mbps
Data Type = 01 1110 (1Eh), RGB 666, 18 UI per Pixel	637 Mbps	487 Mbps	412 Mbps
Data Type = 10 1110 (2Eh), RGB 666 Loosely, 24 UI per Pixel	850 Mbps	650 Mbps	550 Mbps
Data Type = 11 1110 (3Eh), RGB 888, 24 UI per Pixel	850 Mbps	650 Mbps	550 Mbps



### 6.2 High Speed Mode – Data Clock Channel Timing

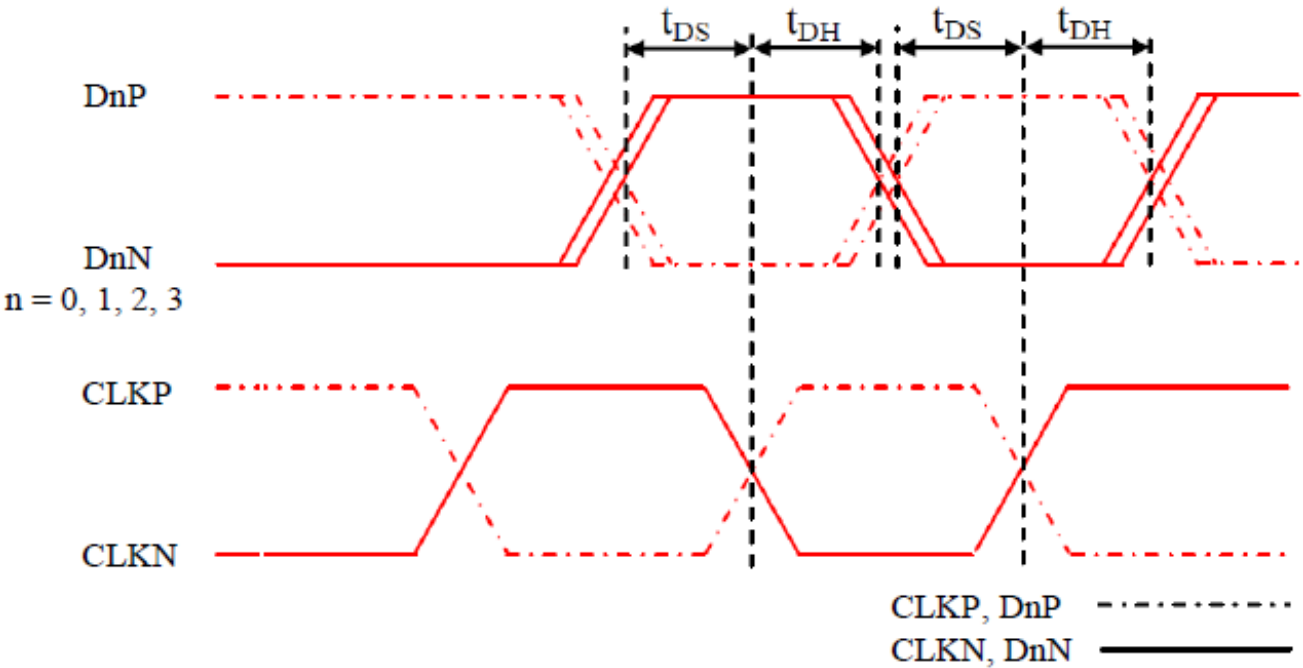


Figure 119: DSI Data to Clock Channel Timings

Table 40: DSI Data to Clock Channel Timings

Signal	Symbol	Parameter	Min	Max
DnP/N , n=0 and 1	$t_{DS}$	Data to Clock Setup time	0.15xUI	-
	$t_{DH}$	Clock to Data Hold Time	0.15xUI	-

### 6.3 High Speed Mode – Rising and Fall Timings

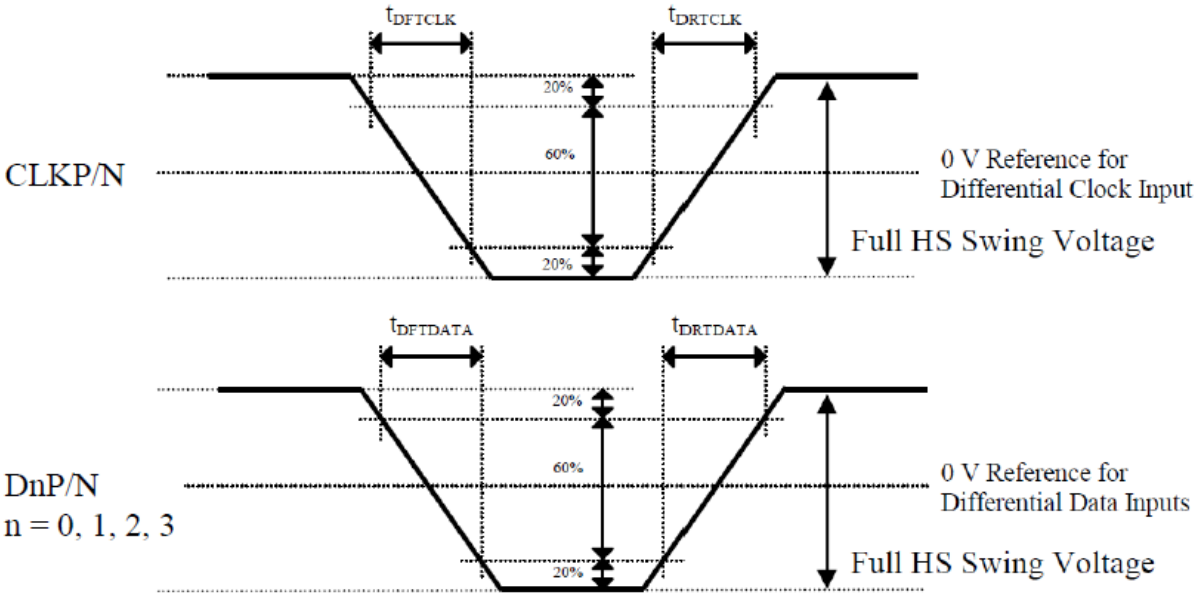


Figure 120: Rising and Falling Timings on Clock and Data Channels

Table 41: Rise and Fall Timings on Clock and Data Channels

Parameter	Symbol	Condition	Specification		
			Min	Typ	Max
Differential Rise Time for Clock	$t_{DRTCLK}$	CLKP/N	150 ps	-	0.3UI (Note)
Differential Rise Time for Data	$t_{DRTDATA}$	DnP/N n=0 and 1	150 ps	-	0.3UI (Note)
Differential Fall Time for Clock	$t_{DFTCLK}$	CLKP/N	150 ps	-	0.3UI (Note)
Differential Fall Time for Data	$t_{DFTDATA}$	DnP/N n=0 and 1	150 ps	-	0.3UI (Note)

**Note:** The display module has to meet timing requirements, which are defined for the transmitter (MCU) on MIPI D-Phy standard.

### 6.4 Low Speed Mode – Bus Turn Around

Lower Power Mode and its State Periods on the Bus Turnaround (BTA) from the MCU to the Display Module (ILI9881C) are illustrated for reference purposes below.

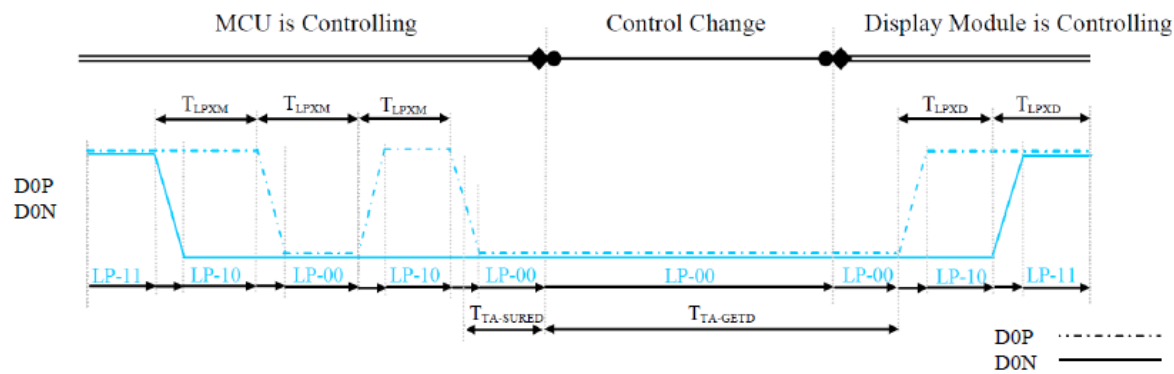


Figure 121: BTA from the MCU to the Display Module

Lower Power Mode and its State Periods on the Bus Turnaround (BTA) from the Display Module (ILI9881C) to the MCU are illustrated for reference purposes below.

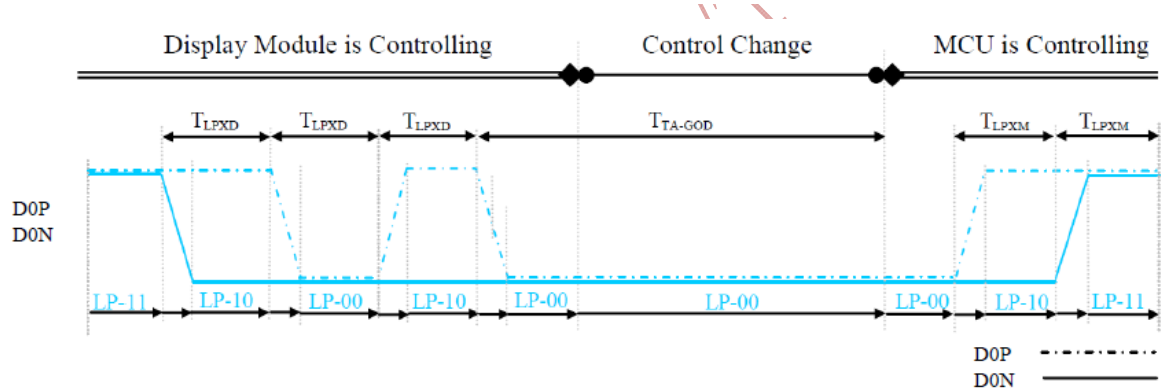


Figure 122: BTA from the Display Module to the MCU

Table 42: Low Power State Period Timings – A

Signal	Symbol	Description	Min	Max	Unit
D0P/N	$T_{LPXM}$	Length of LP-00, LP-01, LP-10 or LP-11 periods MCU → Display Module (ILI9881C)	50	75	ns
D0P/N	$T_{LPXD}$	Length of LP-00, LP-01, LP-10 or LP-11 periods Display Module (ILI9881C) → MCU	50	75	ns
D0P/N	$T_{TA-SURED}$	Time-out before the Display Module (ILI9881C) starts driving	$T_{LPXD}$	$2 \times T_{LPXD}$	ns

Table 43: Low Power State Period Timings – B

Signal	Symbol	Description	Time	Unit
D0P/N	$T_{TA-GETD}$	Time to drive LP-00 by Display Module (ILI9881C)	$5 \times T_{LPXD}$	ns
D0P/N	$T_{TA-GOD}$	Time to drive LP-00 after turnaround request - MCU	$4 \times T_{LPXD}$	ns

## 6.5 Data Lanes from Low Power Mode to High Speed Mode

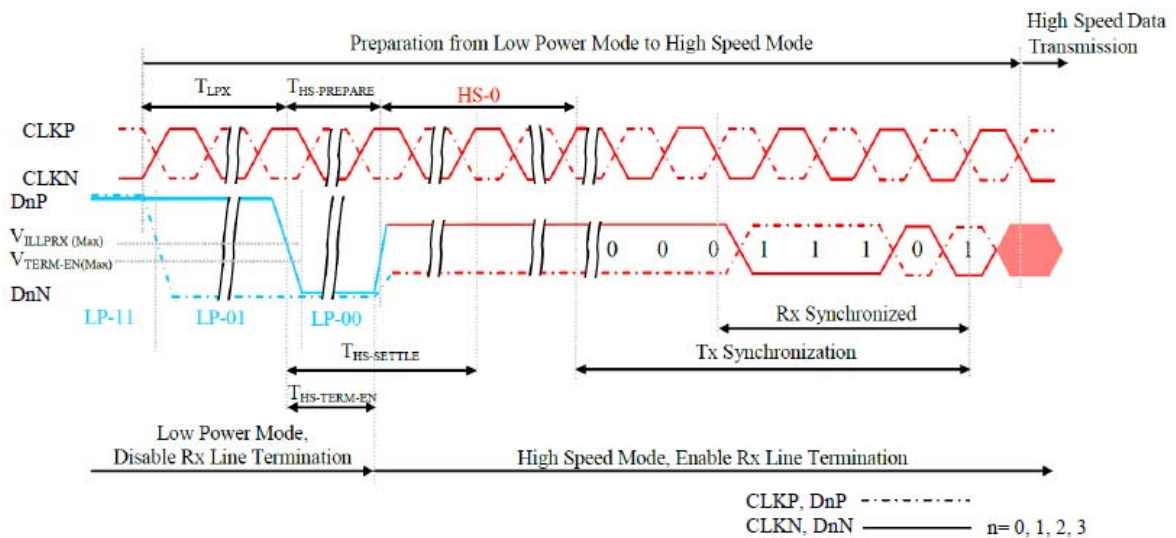


Table 44: Data Lanes - Low Power Mode to High Speed Mode Timings

Signal	Symbol	Description	Min	Max	Unit
DnP/N, n = 0 and 1	$T_{LPX}$	Length of any Low Power State Period	50	-	ns
DnP/N, n = 0 and 1	$T_{HS-PREPARE}$	Time to drive LP-00 to prepare for HS Transmission	$40+4xUI$	$85+6xUI$	ns
DnP/N, n = 0 and 1	$T_{HS-TERM-EN}$	Time to enable Data Lane Receiver line termination measured from when Dn crosses VILMAX	-	$35+4xUI$	ns

6.6 Data Lanes from High Power Mode to High Speed Mode

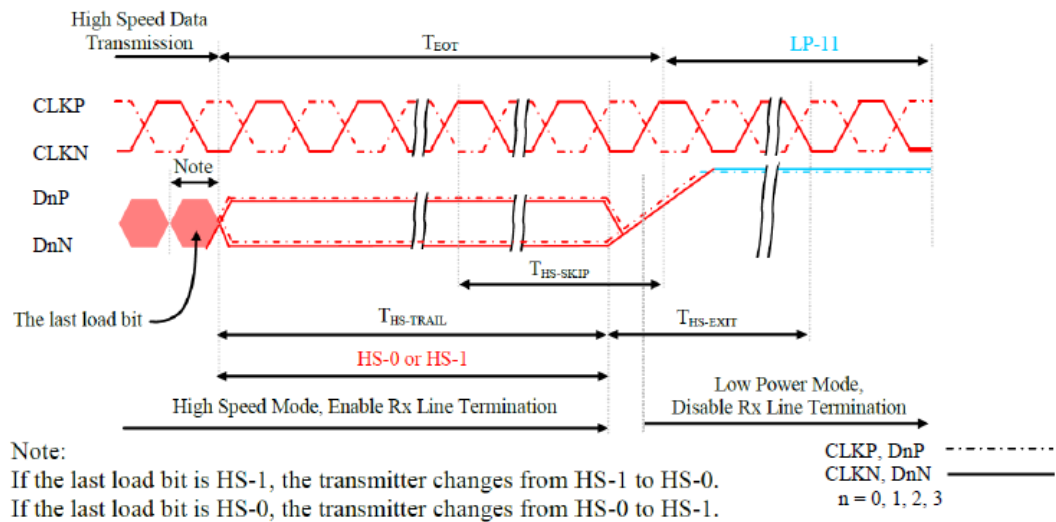


Figure 124: Data Lanes - High Speed Mode to Low Power Mode Timings

Table 45: Data Lanes - High Speed Mode to Low Power Mode Timings

Signal	Symbol	Description	Min	Max	Unit
DnP/N, n = 0 and 1	T <sub>HS-SKIP</sub>	Time-Out at Display Module (ILI9881C) to ignore transition period of EoT	40	55+4xUI	ns
DnP/N, n = 0 and 1	T <sub>HS-EXIT</sub>	Time to driver LP-11 after HS burst	100	-	ns

### 6.7 DSI Clock Burst – High Speed Mode to/from Low Power Mode

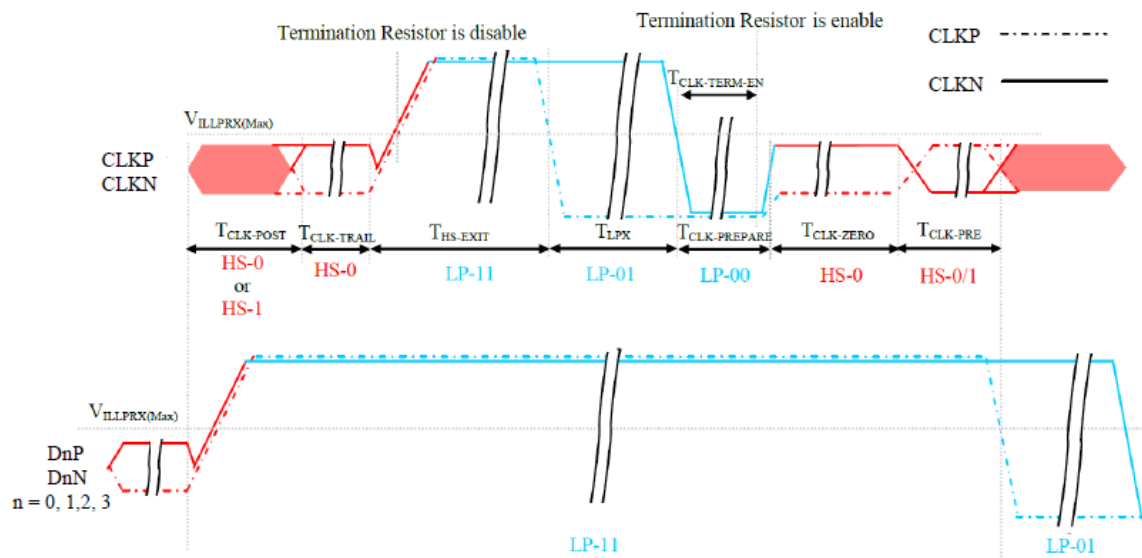
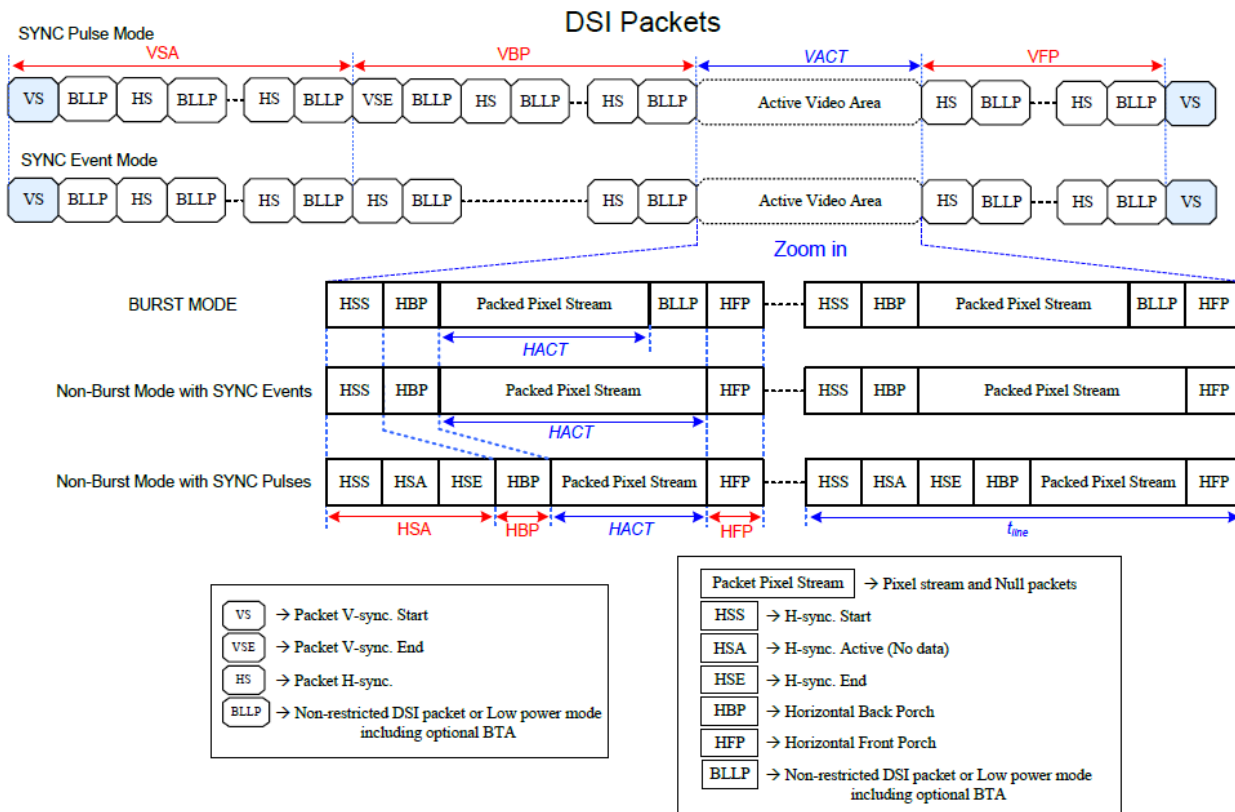


Figure 125: Clock Lanes - High Speed Mode to/from Low Power Mode Timings

Table 46: Clock Lanes - High Speed Mode to/from Low Power Mode Timings

Signal	Symbol	Description	Min	Max	Unit
CLKP/N	$T_{CLK-POST}$	Time that the MCU shall continue sending HS clock after the last associated Data Lanes has transitioned to LP mode	60+52xUI	-	ns
CLKP/N	$T_{CLK-TRAIL}$	Time to drive HS differential state after last payload clock bit of a HS transmission burst	60	-	ns
CLKP/N	$T_{HS-EXIT}$	Time to drive LP-11 after HS burst	100	-	ns
CLKP/N	$T_{CLK-PREPARE}$	Time to drive LP-00 to prepare for HS transmission	38	95	ns
CLKP/N	$T_{CLK-TERM-EN}$	Time-out at Clock Lane to enable HS termination	-	38	ns
CLKP/N	$T_{CLK-PREPARE} + T_{CLK-ZERO}$	Minimum lead HS-0 drive period before starting Clock	300	-	ns
CLKP/N	$T_{CLK-PRE}$	Time that the HS clock shall be driven prior to any associated Data Lane beginning the transition from LP to HS mode	8xUI	-	ns

## 6.8 Timing for DSI video mode



Parameters	Symbols	Min.	Typ.	Max.	Units
Vertical sync. active	VSA	TBD	TBD	-	Line
Vertical Back Porch	VBP	TBD	TBD	-	Line
Vertical Front Porch	VFP	TBD	TBD	-	Line
Active lines per frame	VACT	-	1280	-	Line
Horizontal sync. active	HSA	TBD	TBD	-	Pixel
Horizontal Back Porch	HBP	TBD	TBD	-	Pixel
Horizontal Front Porch	HFP	TBD	TBD	-	Pixel
Active pixels per line	HACT	-	800	-	Pixel
Line time	$t_{line}$	TBD		-	bps/lane
Bit rate	$BR_{bps}$	200		Note 5	Line

1 UI=1/Bit rate

$$HAS(pixel) = (t_{HSA} \times \text{lane number}) / (UI \times \text{pixel format})$$

$$HBP(pixel) = (t_{HBP} \times \text{lane number}) / (UI \times \text{pixel format})$$

$$HFP(pixel) = (t_{HFP} \times \text{lane number}) / (UI \times \text{pixel format})$$

$$\text{Frame Rate} = \frac{BR_{bps} \times \text{Lane}_{num}}{(VACT + VSA + VBP + VFP) \times (HACT + HSA + HBP + HFP) \times \text{Pixel Format}}$$

Example :  $BR_{bps} = 457\text{Mbps/lane}$ ,  $1UI = 2.1883\text{ns}$ , Frame rate=60Hz,  $VACT = 1280$ ,  $VSA = 2$ ,  $VBP = 30$ ,  $VFP = 20$ ,  $HACT = 720$ ,  $HSA = 33$ ,  $HBP = 100$ ,  $HFP = 100$ ,  $\text{Lane}_{num} = 4(\text{lane})$ , Pixel Format=24(bit).

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In Full Range





## Note:

1. Lane<sub>num</sub>: Data lane of MIPI-DSI.
2. Pixel Format: Please reference to "4.1DSI System Interface".
3. The formula exists slightly error because of the host-transmission way.
4. The best frame rate setting : 2 data lanes : 50~60 Hz / 3 data lanes : 50~70 Hz / 4 data lanes : 50~70 Hz.
5. Please reference to "Table 39: Limited Clock Channel Speed"

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	常备库存 Stock For Sale	长期供货 Long Time supply	支持小量 NO MOQ	品种齐全 In Full Range



6.9 Reset input timing

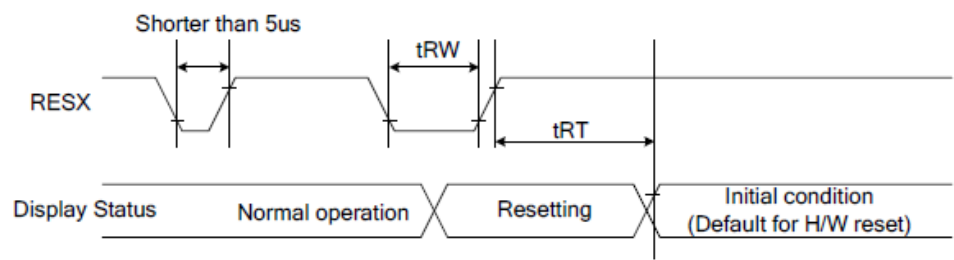


Figure 126: Reset Timing

Table 47: Reset Timing

Signal	Symbol	Parameter	Min	Max	Unit
RESX	tRW	Reset pulse duration	10		uS
	tRT	Reset cancel		5 (note 1,5)	mS
				120 (note 1,6,7)	mS

Notes:

1. The reset cancel also includes required time for loading ID bytes, VCOM setting and other settings from EEPROM to registers. This loading is done every time when there is H/W reset cancel time (tRT) within 5 ms after a rising edge of RESX.
2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the Table 48.

Table 48: Reset Descript

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 10us	Reset
Between 5us and 10us	Reset starts

3. During the Resetting period, the display will be blanked (The display enters the blanking sequence, which maximum time is 120 ms, when Reset Starts in the Sleep Out mode. The display remains the blank state in the Sleep In mode.) and then return to Default condition for Hardware Reset.
4. Spike Rejection can also be applied during a valid reset pulse, as shown below:

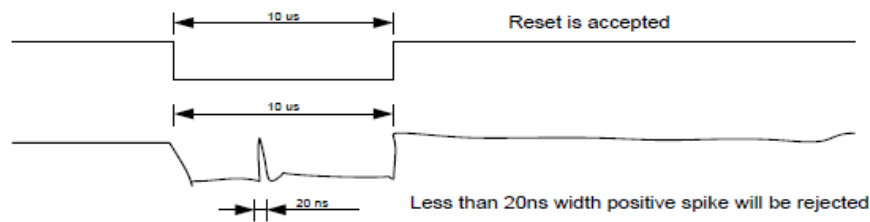


Figure 127: Positive Noise Pulse during Reset Low

5. When Reset applied during Sleep In Mode.
6. When Reset applied during Sleep Out Mode.
7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

## 7. CTP Specification

### 7.1 Electrical Characteristics

#### 7.1.1 Absolute Maximum Rating

Item	Symbol	Min.	Max.	Unit	Note
Power Supply Voltage	VDD	2.66	3.47	V	--
Operating temperature	T <sub>OP</sub>	-20	+70	°C	--
Storage temperature	T <sub>ST</sub>	-30	+80	°C	--

#### 7.1.2 DC Electrical Characteristics (Ta=25°C)

(Ambient temperature:25°C, AVDD=2.8V, VDDIO=1.8V or VDDIO=AVDD)

Item	Min.	Typ.	Max.	Unit	Note
Normal mode operating current	--	8	14.5	mA	
Green mode operating current	--	3.3	--	mA	
Sleep mode operating current	70	--	120	uA	
Doze mode operating current	--	0.78	--	mA	
Digital Input low voltage/VIL	-0.3	--	0.25*VDD	V	
Digital Input high voltage/VIH	0.75*VDD	--	VDD+0.3	V	
Digital Output low voltage/VOL	--		0.15*VDD	V	
Digital Output high voltage/VOH	0.85*VDD			V	

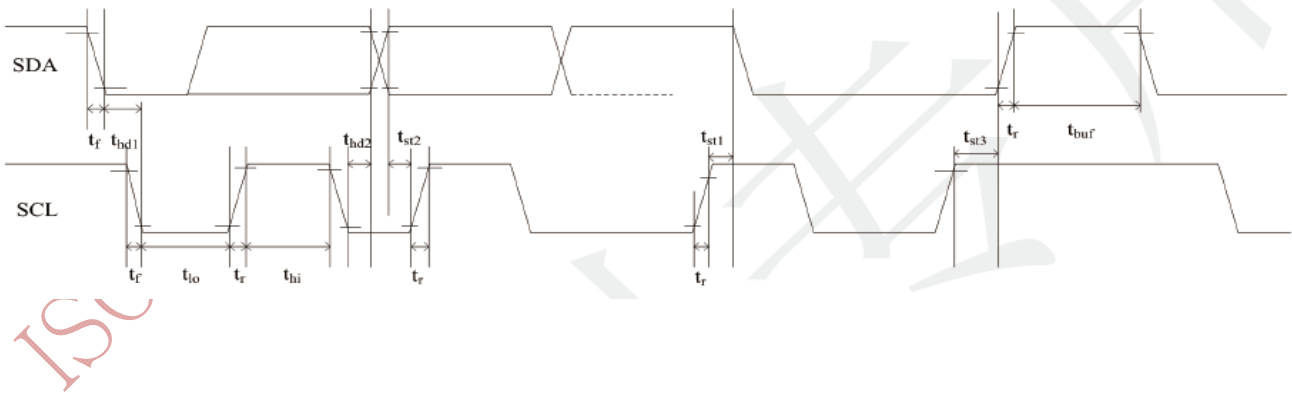
### 7.1.3 AC Characteristics

(Ambient temperature:25℃, AVDD=2.8V, VDDIO=1.8V)

Parameter	Min	Typ	Max	Unit
OSC oscillation frequency	59	60	61	MHZ
I/O output rise time,low to high	-	14	-	ns
I/O output rfall time,high to low	-	14	-	ns

### 7.2 I2C Timing

GT911 provides a standard I2C interface for SCL and SDA to communicate with the host. GT911 always serves as slave device in the system with all communication being initialized by the host. It is strongly recommended that transmission rate be kept at or below 400Kbps. The I2C timing is shown below:



**Test condition 1: 1.8V host interface voltage, 400Kbps transmission rate, 2K pull-up resistor**

Parameter	Symbol	Min.	Max.	Unit
SCL low period	$t_{lo}$	1.3	-	us
SCL high period	$t_{hi}$	0.6	-	us
SCL setup time for Start condition	$t_{st1}$	0.6	-	us
SCL setup time for Stop condition	$t_{st3}$	0.6	-	us
SCL hold time for Start condition	$t_{hd1}$	0.6	-	us
SDA setup time	$t_{st2}$	0.1	-	us
SDA hold time	$t_{hd2}$	0	-	us

**Test condition 2: 3.3V host interface voltage, 400Kbps transmission rate, 2K pull-up resistor**

Parameter	Symbol	Min.	Max.	Unit
SCL low period	$t_{lo}$	1.3	-	us
SCL high period	$t_{hi}$	0.6	-	us
SCL setup time for Start condition	$t_{st1}$	0.6	-	us
SCL setup time for Stop condition	$t_{st3}$	0.6	-	us
SCL hold time for Start condition	$t_{hd1}$	0.6	-	us
SDA setup time	$t_{st2}$	0.1	-	us
SDA hold time	$t_{hd2}$	0	-	us

GT911 supports two I2C slave addresses: 0xBA/0xBB and 0x28/0x29. The host can select the address by changing the status of Reset and INT pins during the power-on initialization phase. See the diagram below for configuration methods and timings:

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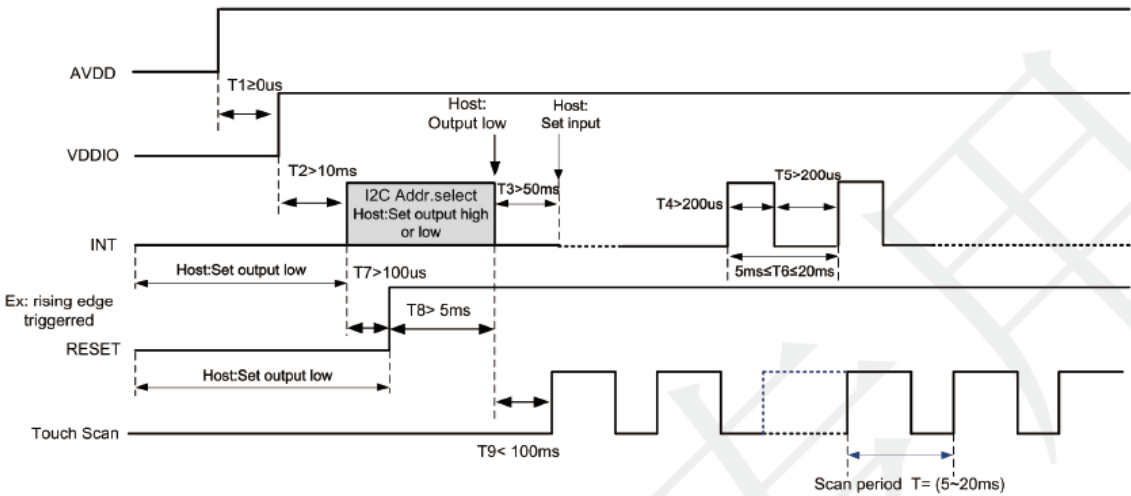
常备库存  
Stock For Sale

长期供货  
Long Time supply

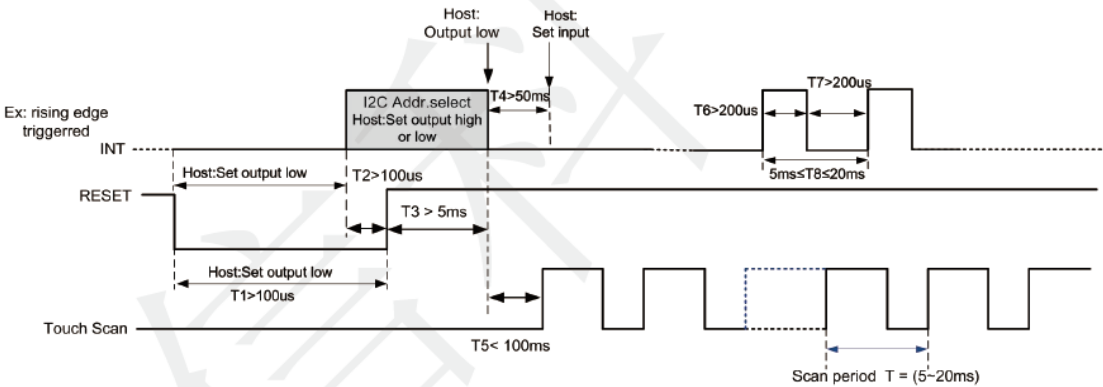
支持小量  
NO MOQ

品种齐全  
In Full Range

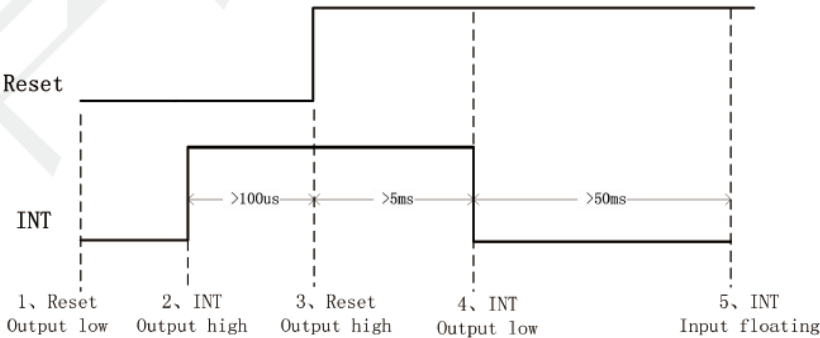
Power-on Timing:



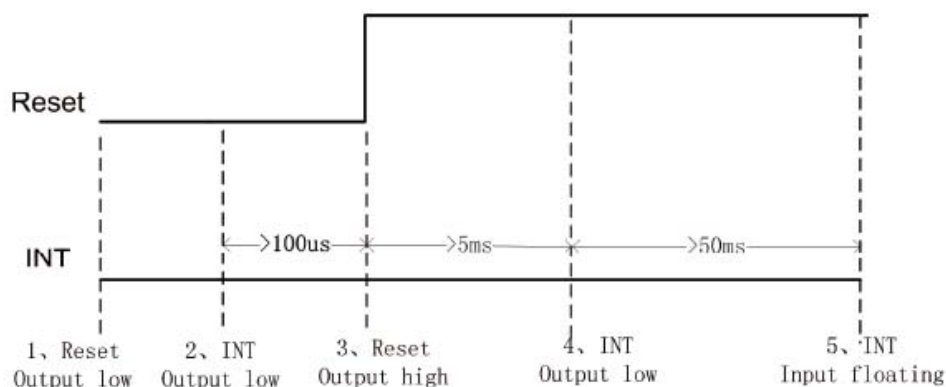
Timing for host resetting GT911:



Timing for setting slave address to 0x28/0x29:



### Timing for setting slave address to 0xBA/0xBB:



### a) Data Transmission

(For example: device address is 0xBA/0xBB)

Communication is always initiated by the host. Valid Start condition is signaled by pulling SDA line from “high” to “low” when SCL line is “high”. Data flow or address is transmitted after the Start condition.

All slave devices connected to I<sup>2</sup>C bus should detect the 8-bit address issued after Start condition and send the correct ACK. After receiving matching address, GT911 acknowledges by configuring SDA line as output port and pulling SDA line low during the ninth SCL cycle. When receiving unmatched address, namely, not 0XBA or 0XBB, GT911 will stay in an idle state.

For data bytes on SDA, each of 9 serial bits will be sent on nine SCL cycles. Each data byte consists of 8 valid data bits and one ACK or NACK bit sent by the recipient. The data transmission is valid when SCL line is “high”.

When communication is completed, the host will issue the STOP condition. Stop condition implies the transition of SDA line from “low” to “high” when SCL line is “high”.

## b) Writing Data to GT911

(For example: device address is 0xBA/0xBB)



### Timing for Write Operation

The diagram above displays the timing sequence of the host writing data onto GT911. First, the host issues a Start condition. Then, the host sends 0xBA (address bits and R/W bit; R/W bit as 0 indicates Write operation) to the slave device.

After receiving ACK, the host sends the 16-bit register address (where writing starts) and the 8-bit data bytes (to be written onto the register).

The location of the register address pointer will automatically add 1 after every Write Operation. Therefore, when the host needs to perform Write Operations on a group of registers of continuous addresses, it is able to write continuously. The Write Operation is terminated when the host issues the Stop condition.

c) Reading Data from GT911

(For example: device address is 0xBA/0xBB)



Timing for Read Operation

The diagram above is the timing sequence of the host reading data from GT911. First, the host issues a Start condition and sends 0xBA (address bits and R/W bit; R/W bit as 0 indicates Write operation) to the slave device.

After receiving ACK, the host sends the 16-bit register address (where reading starts) to the slave device. Then the host sets register addresses which need to be read.

Also after receiving ACK, the host issues the Start condition once again and sends 0xBB (Read Operation). After receiving ACK, the host starts to read data.

GT911 also supports continuous Read Operation and, by default, reads data continuously. Whenever receiving a byte of data, the host sends an ACK signal indicating successful reception. After receiving the last byte of data, the host sends a NACK signal followed by a STOP condition which terminates communication.



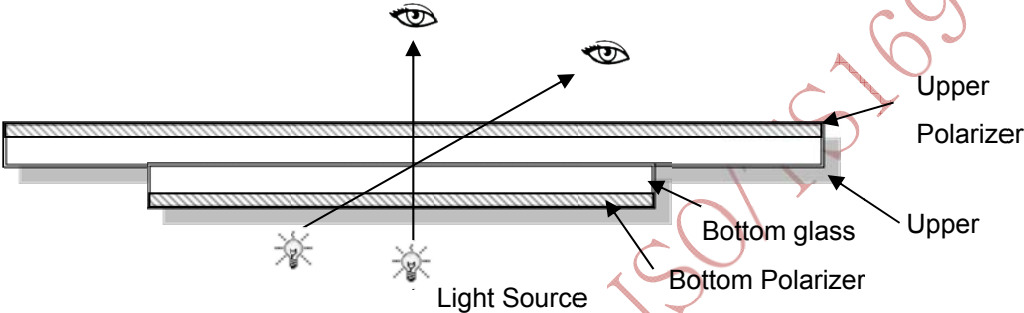
## 8. LCD Module Out-Going Quality Level

### 8.1 VISUAL & FUNCTION INSPECTION STANDARD

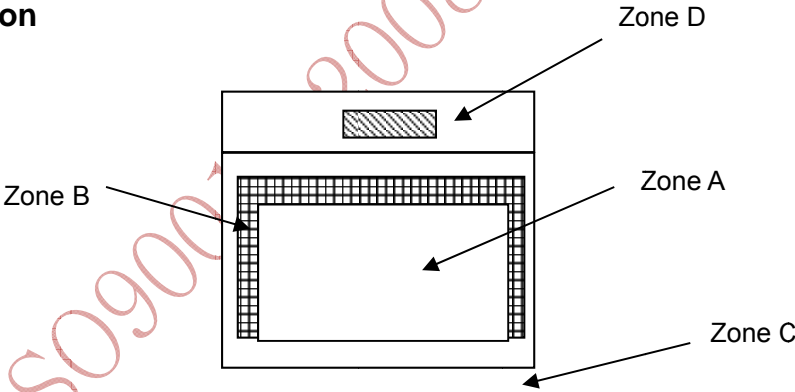
#### 8.1.1 Inspection conditions

Inspection performed under the following conditions is recommended.

- Temperature : 25±5℃
- Humidity : 65%±10%RH
- Viewing Angle : Normal viewing Angle.
- Illumination: Single fluorescent lamp (300 to 700Lux)
- Viewing distance:30-50cm



#### 8.1.2 Definition



- Zone A : Effective Viewing Area(Character or Digit can be seen)
- Zone B : Viewing Area except Zone A
- Zone C Cover (Zone A+Zone B) which can not be seen after assembly by customer .)
- Zone D : IC Bonding Area

Note:As a general rule ,visual defects in Zone C can be ignored when it doesn't effect product function or appearance after assembly by customer

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常备库存 Stock For Sale		长期供货 Long Time supply	支持小量 NO MOQ	品种齐全 In Full Range



### 8.1.3 Sampling Plan

According to GB/T 2828-2003 ; , normal inspection, Class II

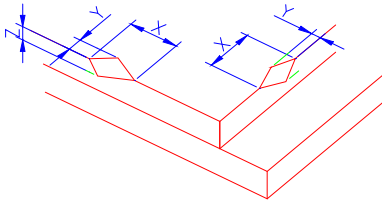
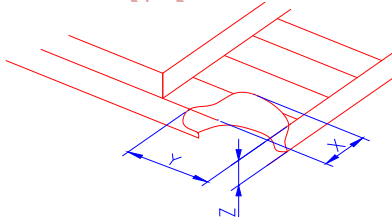
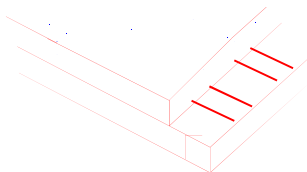
AQL:

Major defect	Minor defect
0.65	1.5

LCD: Liquid Crystal Display , TP: Touch Panel , LCM: Liquid Crystal Module

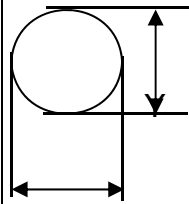
No	Items to be inspected	Criteria	Classification of defects
1	Functional defects	1) No display, Open or miss line 2) Display abnormally, Short 3) Backlight no lighting, abnormal lighting. 4) TP no function	Major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	
4	Color tone	Color unevenness, refer to limited sample	Minor
5	Spot Line defect	Light dot , Dim spot , Polarizer Bubble ; Polarizer accidented spot.	
6	Soldering appearance	Good soldering , Peeling off is not allowed.	
7	LCD/Polarizer/TP	Black/White spot/line, scratch, crack, etc.	

### 8.1.4 Criteria (Visual)

Number	Items	Criteria(mm)						
1.0 LCD Crack/Broken NOTE: X: Length Y: Width Z: Height L: Length of ITO, T: Height of LCD	(1) The edge of LCD broken	<div></div> <table><tr><td>X</td><td>Y</td><td>Z</td></tr><tr><td>≤3.0mm</td><td>&lt;Inner border line of the seal</td><td>≤T</td></tr></table>	X	Y	Z	≤3.0mm	<Inner border line of the seal	≤T
	X	Y	Z					
	≤3.0mm	<Inner border line of the seal	≤T					
(2)LCD corner broken	<div></div> <table><tr><td>X</td><td>Y</td><td>Z</td></tr><tr><td>≤3.0mm</td><td>≤L</td><td>≤T</td></tr></table>	X	Y	Z	≤3.0mm	≤L	≤T	
X	Y	Z						
≤3.0mm	≤L	≤T						
(3) LCD crack	<div></div> <div>Crack Not allowed</div>							

2.0

Spot defect



X

Φ=(X+Y)/2

① light dot (LCD/TP/Polarizer black/white spot , light dot, pinhole, dent, stain)

Zone Size (mm)	Acceptable Qty		
	A	B	C
Φ≤0.10	Ignore		
0.10<Φ≤0.25	4( distance ≥ 10mm)		
0.25<Φ≤0.35	3		
Φ>0.4	0		

②Dim spot (LCD/TP/Polarizer dim dot, light leakage、dark spot)

Zone Size (mm)	Acceptable Qty		
	A	B	C
Φ≤0.1	Ignore		
0.10<Φ≤0.25	4( distance ≥ 10mm)		
0.25<Φ≤0.35	3		
Φ>0.4	0		

③ Polarizer accidented spot

Zone Size (mm)	Acceptable Qty		
	A	B	C
Φ≤0.2	Ignore		
0.3<Φ≤0.5	3( distance ≥ 10mm)		
Φ>0.5	1		

④Pixel bad points (light dot, Dim dot, color dot)

Zone Size (mm)	Acceptable Qty		
	A	B	C
Φ≤0.15	Ignore		
0.2<Φ≤0.3	2( distance ≥ 10mm)		
Φ>0.4	1		

⑤ Polarizer Bubble

Zone Size (mm)	Acceptable Qty		
	A	B	C
Φ≤0.2	Ignore		
0.3<Φ≤0.4	4(distance ≥ 10 m)		
0.4<Φ≤0.5	3		
Φ>0.5	1		

3.0	Line defect (LCD/TP /Polarizer backlight black/white line, scratch, stain)	<div>Width(mm)</div>	<div>Length(m m)</div>	Acceptable Qty			
				A	B	C	
		$\Phi\leq0.05$	Ignore	Ignore			Ignore
		$0.05<W\leq0.06$	$L\leq4.0$	$N\leq3$			
		$0.07<W\leq0.08$	$L\leq3.0$	$N\leq2$			
$0.08<W$	Define as spot defect						
4.0	Electronic Comp onents SMT	Not allow missing parts, solderless connection, cold solder joint, mis match, The positive and negative polarity opposite					
5.0	Display color& B rightness	<div>1. Color: Measuring the color coordinates, The measurement standar d according to the datasheet or samples.</div> <div>2. Brightness: Measuring the brightness of White screen, The meas urement standard according to the datasheet or Samples.</div>					

6.0	CTP Related	CTP Cover sensor accidented black/white spot					
			Size $\Phi$ (mm)	Acceptable Qty			
				A	B	C	
			$\Phi \leq 0.1$	Ignore		Ignore	
			$0.15 < \Phi \leq 0.25$	4 (distance $\geq 10\text{mm}$ )			
			$0.25 < \Phi \leq 0.35$	3			
		$\Phi > 0.4$	1				
		CTP Cover scratch					
			Width(mm)	Ignore( mm)	Acceptable Qty		
					A	B	C
			$\Phi \leq 0.05$	Ignore	Ignore		
			$0.05 < W \leq 0.06$	$L \leq 4.0$	$N \leq 3$		
$0.07 < W \leq 0.08$	$L \leq 3.0$		$N \leq 2$				
$0.08 < W$	Define as spot defect						

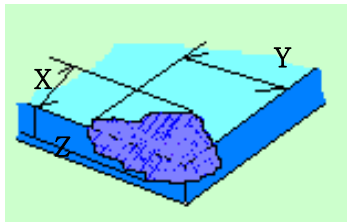
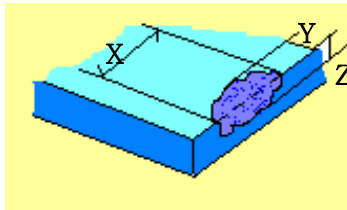
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常备库存  
Stock For Sale

长期供货  
Long Time supply

支持小量  
NO MOQ

品种齐全  
In Full Range

		<div>CTP Cover Pinhole/ Lack of ink</div> <table><tr><th><div>Zone</div><div>Size (mm)</div></th><th>Acceptable Qty</th></tr><tr><td><math>\Phi \leq 0.2</math></td><td>C</td></tr><tr><td><math>0.2 &lt; \Phi \leq 0.3</math></td><td>Ignore</td></tr><tr><td><math>0.3 &lt; \Phi \leq 0.4</math></td><td>4(distance <math>\geq 10\text{mm}</math>)</td></tr><tr><td><math>\Phi &gt; 0.4</math></td><td>3</td></tr><tr><td></td><td>0</td></tr></table>	<div>Zone</div> <div>Size (mm)</div>	Acceptable Qty	$\Phi \leq 0.2$	C	$0.2 < \Phi \leq 0.3$	Ignore	$0.3 < \Phi \leq 0.4$	4(distance $\geq 10\text{mm}$ )	$\Phi > 0.4$	3		0					
<div>Zone</div> <div>Size (mm)</div>	Acceptable Qty																		
$\Phi \leq 0.2$	C																		
$0.2 < \Phi \leq 0.3$	Ignore																		
$0.3 < \Phi \leq 0.4$	4(distance $\geq 10\text{mm}$ )																		
$\Phi > 0.4$	3																		
	0																		
	<div>CTP Bonding bubble/ accident spot</div> <table><tr><th>Size <math>\Phi(\text{mm})</math></th><th colspan="2">Acceptable Qty</th></tr><tr><td></td><th>A</th><th>B</th></tr><tr><td><math>\Phi \leq 0.1</math></td><td colspan="2">Ignore</td></tr><tr><td><math>0.15 &lt; \Phi \leq 0.2</math></td><td colspan="2">3(distance <math>\geq 10\text{mm}</math>)</td></tr><tr><td><math>0.2 &lt; \Phi \leq 0.25</math></td><td colspan="2">2</td></tr><tr><td><math>\Phi &gt; 0.25</math></td><td colspan="2">0</td></tr></table>	Size $\Phi(\text{mm})$	Acceptable Qty			A	B	$\Phi \leq 0.1$	Ignore		$0.15 < \Phi \leq 0.2$	3(distance $\geq 10\text{mm}$ )		$0.2 < \Phi \leq 0.25$	2		$\Phi > 0.25$	0	
Size $\Phi(\text{mm})$	Acceptable Qty																		
	A	B																	
$\Phi \leq 0.1$	Ignore																		
$0.15 < \Phi \leq 0.2$	3(distance $\geq 10\text{mm}$ )																		
$0.2 < \Phi \leq 0.25$	2																		
$\Phi > 0.25$	0																		
	Assembly deflection	beyond the edge of backlight $\leq 0.2\text{mm}$																	
	<div>TP cover broken X : length Y : width Z : height</div> <table><tr><th>X</th><th>Y</th><th>Z</th></tr><tr><td><math>X \leq 0.5\text{mm}</math></td><td><math>Y \leq 0.5\text{mm}</math></td><td><math>Z &lt; \text{cover thickness}</math></td></tr></table> <div>Circuitry broken is not allowed.</div>	X	Y	Z	$X \leq 0.5\text{mm}$	$Y \leq 0.5\text{mm}$	$Z < \text{cover thickness}$												
X	Y	Z																	
$X \leq 0.5\text{mm}$	$Y \leq 0.5\text{mm}$	$Z < \text{cover thickness}$																	
	<div>TP cover broken X : length Y : width Z : height</div> <table><tr><th>X</th><th>Y</th><th>Z</th></tr><tr><td><math>X \leq 0.3\text{mm}</math></td><td><math>Y \leq 0.3\text{mm}</math></td><td><math>Z &lt; \text{LCD thickness}</math></td></tr></table> <div>* Circuitry broken is not allowed.</div>	X	Y	Z	$X \leq 0.3\text{mm}$	$Y \leq 0.3\text{mm}$	$Z < \text{LCD thickness}$												
X	Y	Z																	
$X \leq 0.3\text{mm}$	$Y \leq 0.3\text{mm}$	$Z < \text{LCD thickness}$																	

Criteria ( functional items)

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Number	Items	Criteria (mm)
1	No display	Not allowed
2	Missing segment	Not allowed
3	Short	Not allowed
4	Backlight no lighting	Not allowed
5	TP no function	Not allowed

ISO9001 : 2008      ISO/TS16949 : 2009

## 9. Reliability Test Result

### 9.1 Condition

Item	Condition	Sample Size	Test Result	Note
Low Temperature Operating Life test	-20℃, 96HR	3ea	pass	-
Thermal Humidity Operating Life test	70℃90%RH, 96HR	3ea	pass	-
Temperature Cycle ON/OFF test	-20℃ ↔ 70℃, ON/OFF, 20CYC	3ea	pass	(1)
High Temperature Storage test	80℃, 96HR	3ea	pass	-
Low Temperature Storage test	-30℃, 96HR	3ea	pass	-
ESD test	150pF, 330Ω, ±6KV(Contact)/± 8KV(Air), 5 points/panel, 10 times/point	3ea	pass	
Thermal Shock Resistance	The sample should be allowed to stand the following 5 cycles of operation: TSTL for 30 minutes -> normal temperature for 5 minutes -> TSTH for 30 minutes -> normal temperature for 5 minutes, as one cycle, then taking it out and drying it at normal temperature, and allowing it stand for 24 hours	3ea	pass	
Box Drop Test	1 Corner 3 Edges 6 faces, 66cm(MEDIUM BOX)	1box	pass	-

Note (1) ON Time over 10 seconds, OFF Time under 10 seconds

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常备库存  
Stock For Sale

长期供货  
Long Time supply

支持小量  
NO MOQ

品种齐全  
In Full Range

## 10. Cautions and Handling Precautions

### 10.1 Handling and Operating the Module

- (1) When the module is assembled, it should be attached to the system firmly.  
Do not warp or twist the module during assembly work.
- (2) Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.
- (3) Note that polarizer is very fragile and could be easily damaged. Do not press or scratch the surface.
- (4) Do not allow drops of water or chemicals to remain on the display surface.  
If you have the droplets for a long time, staining and discoloration may occur.
- (5) If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.
- (6) The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane.  
Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.
- (7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.
- (8) Protect the module from static; it may cause damage to the CMOS ICs.
- (9) Use finger-stalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.
- (10) Do not disassemble the module.
- (11) Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.
- (12) Pins of I/F connector shall not be touched directly with bare hands.
- (13) Do not connect, disconnect the module in the "Power ON" condition.
- (14) Power supply should always be turned on/off by the item 6.1 Power On Sequence & 6.2 Power Off Sequence

### 10.2 Storage and Transportation.

- (1) Do not leave the panel in high temperature, and high humidity for a long time.  
It is highly recommended to store the module with temperature from 0 to 35 °C and relative humidity of less than 70%
- (2) Do not store the TFT-LCD module in direct sunlight.
- (3) The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.
- (4) It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module.  
In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.
- (5) This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.

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常备库存 Stock For Sale		长期供货 Long Time supply	支持小量 NO MOQ	品种齐全 In Full Range





11. Packing

---TBD-----

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常 备 库 存 Stock For Sale		长 期 供 货 Long Time supply	支持小量 NO MOQ	品 种 齐 全 In Full Range